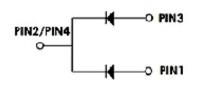




DUAL COMMON CATHODE SCHOTTKY BARRIER RECTIFIER







TO-220AB Leaded Plastic Package RoHS compliant

TO-220AB

FEATURES:

PRIMARY USE

- 1. Low Voltage High Frequency Switching Power Supply
- 2. Low Voltage High Frequency Invers Circuit.
- 3. Low Voltage Continued Circuit and Protection Circuit.

ABSOLUTE MAXIMUM RATINGS (Ta = 25 °CUnless otherwise specified)

7 BOOLOTE III BUILDIN TOTTINGO (14 Zo Conness curer wise specifica)						
PARAMETER	SYMBOL	VALUE	UNIT			
Maximal Inverted Repetitive Peak Voltage	V_{RRM}	150	V			
Average Rectified Forward Current (Rated VR-20KHz Square Wave) - 50% duty cycle ¹	I _{FAV}	20	А			
Typical Thermal Resistance(per leg) Package =TO-220AB	$R_{ heta Jc}$	2	°C/W			
Forward Peak Surge Current(Rated Load 8.3 Half Mssine Wave-According to JEDEC Method)	I _{FSM}	290	А			
Maximum Rate of Voltage Change (at Rated V_R)	dv/dt	10000	V/µs			
Peak Repetitive Reverse Surge Current (2µs-1KHz)	I _{RRM}	0.5	А			
Operating Junction Temperature	TJ	150	°C			
Storage Temperature	T _{stg}	-40 to +150	°C			

ELECTRICAL CHARACTERISTICS at (Ta = 25 °C Unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITION		MIN	TYP	MAX	UNIT
Maximum Reverse Current at Rated	ı	$T_J = 25^{\circ}C$	\/ -150\/	1		0.02	mA
DC Blocking Voltage	I _R	T _J = 125°C	V _R =150V	1		3.00	mA
Maximum instantaneous Forward	V _F —	$T_J = 25^{\circ}C$	I _F =10A	1	0.82	0.88	V
Voltage per leg		T _J = 125°C				0.77	V

Note:

1. $I_{F(AV)} = 10A \times 2$



Continental Device India Pvt. Limited

An IATF 16949, ISO9001 and ISO 14001 Certified Company



TYPICAL CHARACTERISTICS CURVES

Fig 1: The forward voltage and forward current curve

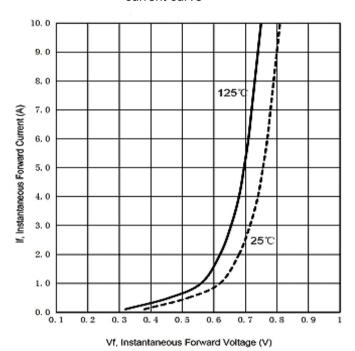


Fig 2: Current derating curve, perelement

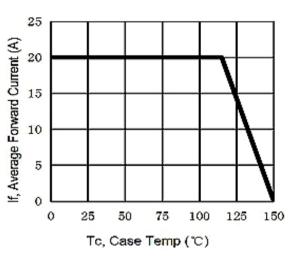
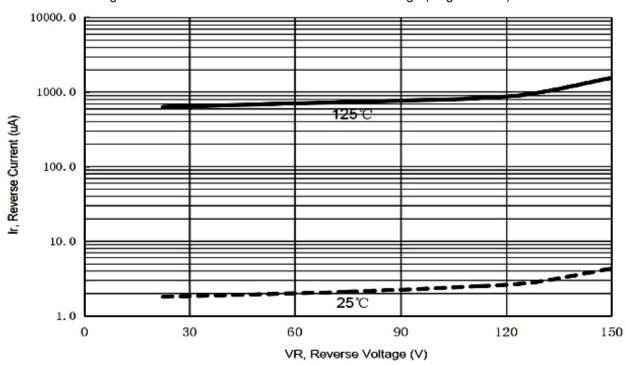


Fig 3: The reverse leak current and the reverse voltage (single-device) curve.

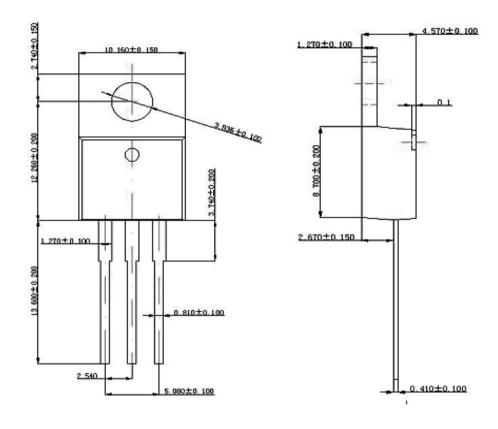






PACKAGE DETAIL

TO-220AB Plastic Package







Recommended Product Storage Environment for Discrete Semiconductor Devices

This storage environment assumes that the Diodes and transistors are packed properly inside the original packing supplied by CDIL.

- · Temperature 5 °C to 30 °C
- · Humidity between 40 to 70 %RH
- · Air should be clean.
- Avoid harmful gas or dust.
- · Avoid outdoor exposure or storage in areas subject to rain or water spraying.
- · Avoid storage in areas subject to corrosive gas or dust. Product shall not be stored in areas exposed to direct sunlight.
- · Avoid rapid change of temperature.
- · Avoid condensation.
- · Mechanical stress such as vibration and impact shall be avoided.
- · The product shall not be placed directly on the floor.
- · The product shall be stored on a plane area. They should not be turned upside down.

They should not be placed against the wall.

Shelf Life of CDIL Products

The shelf life of products is the period from product manufacture to shipment to customers. The product can be unconditionally shipped within this period. The period is defined as 2 years.

If products are stored longer than the shelf life of 2 years the products shall be subjected to quality check as per CDIL quality procedure.

The products are further warranted for another one year after the date of shipment subject to the above conditions in CDIL original packing.

Floor Life of CDIL Products and MSL Level

When the products are opened from the original packing, the floor life will start.

For this, the following JEDEC table may be referred:

JEDEC MSL Level				
Level	Time	Condition		
1	Unlimited	≤30 °C / 85% RH		
2	1 Year	≤30 °C / 60% RH		
2a	4 Weeks	≤30 °C / 60% RH		
3	168 Hours	≤30 °C / 60% RH		
4	72 Hours	≤30 °C / 60% RH		
5	48 Hours	≤30 °C / 60% RH		
5a	24 Hours	≤30 °C / 60% RH		
6	Time on Label(TOL)	≤30 °C / 60% RH		





Customer Notes

Component Disposal Instructions

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

CDIL strives for continuous improvement and reserves the right to change the specifications of its products without prior notice.



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